

BUL742C HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

Ordering Code	Marking	Package / Shipment
BUL742C	BUL742C	TO-220 / Tube

- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
 MINIMUM LOT-TO-LOT SPREAD FOR
- RELIABLE OPERATION VERY HIGH SWITCHING SPEED

APPLICATIONS:

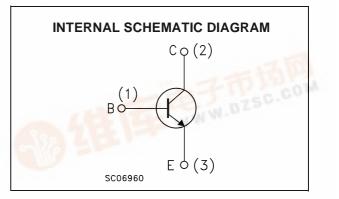
- ELECTRONIC BALLAST FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

DESCRIPTION

The device is manufactured using High Voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability.

Thanks to an increased intermediate layer, it has an intrinsic ruggedness which enables the transistor to withstand an high collector current level during breakdown condition, without using the transil protection usually necessary in typical converters for lamp ballast.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	1050		
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V	
V _{EBO}	Emitter-Base Voltage ($I_C = 0$, $I_B < 2$ A, $t_p < 10$ ms)	V(BR)EBO	V	
Ic	Collector Current	4		
I _{CM}	Collector Peak Current (tp < 5 ms)	8		
IB	Base Current	2		
IBM	Base Peak Current (t _p < 5 ms)	4		
Ptot	Total Dissipation at $T_c = 25 \text{ °C}$	70		
T _{stg}	Storage Temperature	-65 to 150		
Tj	Max. Operating Junction Temperature	150	°C	



BUL742C

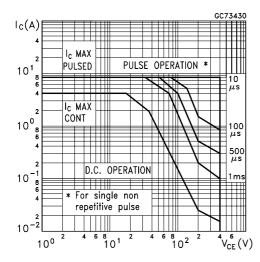
THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Max	1.79	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_j = 25 °C unless otherwise specified)

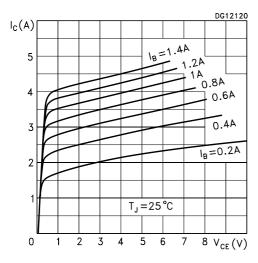
Symbol	Parameter	Test C	onditions	Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 1050 V				100	μA
I _{CEO}	Collector Cut-off Current (I _B = 0)	V _{CE} = 400 V				250	μA
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = 1 mA		12		24	V
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage $(I_B = 0)$	I _C = 10 mA		400			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_{C} = 1 A$ $I_{C} = 3.5 A$	I _B = 0.2 A I _B = 1 A			0.5 1.5	V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 3.5 A	I _B = 1 A			1.5	V
h _{FE} *	DC Current Gain	I _C = 0.1 A I _C = 0.8 A	V _{CE} = 5 V V _{CE} = 3 V	48 25		100 50	
t _s t _f	RESISTIVE LOAD Storage Time Fall Time	$ I_C = 2 A I_{B1} = -I_{B2} = 400 \text{ mA} V_{BB(off)} = -5 \text{ V} $	V _{CC} = 125 V t _p = 300 μs (See Figure 1)		2.4 350		µs ns
E _{ar}	Repetitive Avalanche Energy	L = 2 mH V _{BE} = -5 V	C = 1.8 nF (See Figure 2)	6			mJ

* Pulsed: Pulse duration = 300 μ s, duty cycle = 1.5 %.



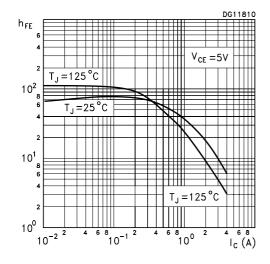
Output Characteristics

Safe Operating Area

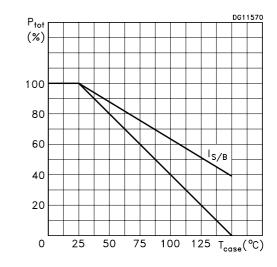


DC Current Gain

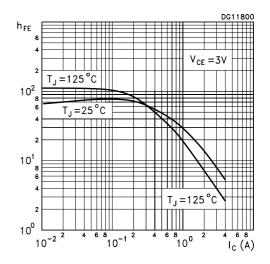
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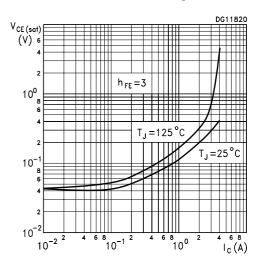
Derating Curve



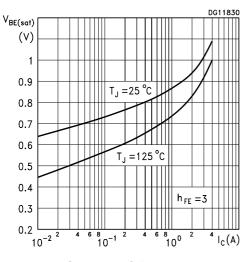
DC Current Gain



Collector-Emitter Saturation Voltage

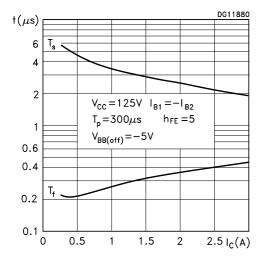


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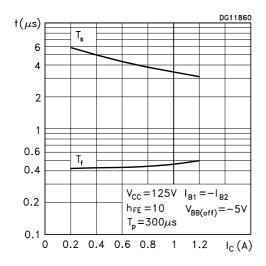


Base-Emitter Saturation Voltage

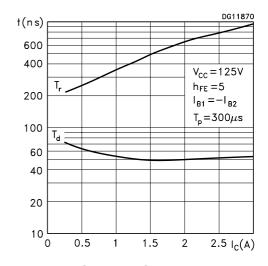
Resistive Load Switching Off Times



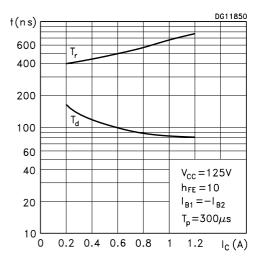
Resistive Load Switching Off Times



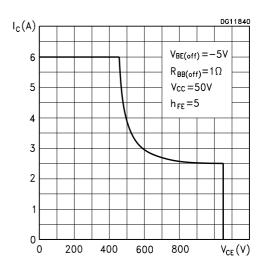
Resistive Load Switching On Times



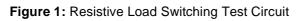
Resistive Load Switching On Times



Reverse Biased Safe Operating Area



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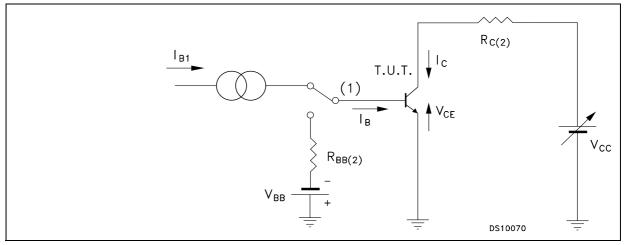
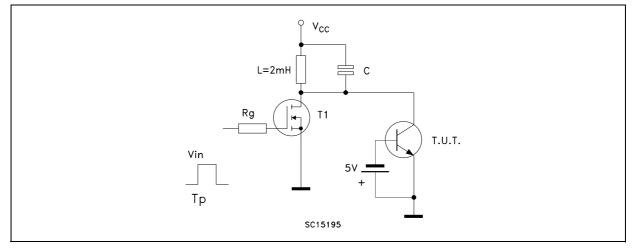


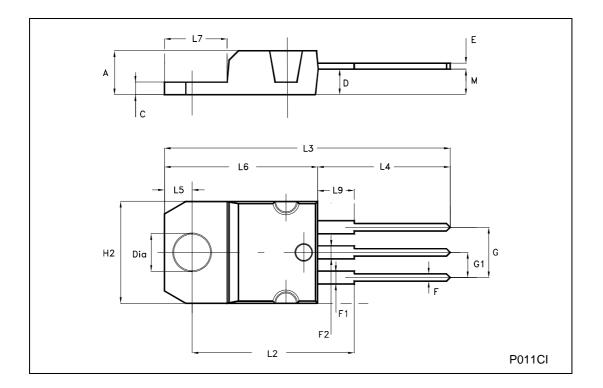
Figure 2: Energy Rating Test Circuit

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5.04	mm		inch			
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.052
D	2.40		2.72	0.094		0.107
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.202
G1	2.40		2.70	0.094		0.106
H2	10.00		10.40	0.394		0.409
L2		16.40			0.645	
L4	13.00		14.00	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.20		6.60	0.244		0.260
L9	3.50		3.93	0.137		0.154
М		2.60			0.102	
DIA.	3.75		3.85	0.147		0.151

TO-220 MECHANICAL DATA



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